

Overview

The purpose of this notification is to communicate that Xilinx has retracted the qualification of a new assembly supplier for Hi-Rel (XQ) FPGA PQ240 package due to extension of production capability.

Description

The purpose of this notification is to communicate that Xilinx has retracted the assembly supplier change for the Xilinx Hi-Rel (XQ) FPGA device in the PQ240 package. The current assembly supplier has extended the production of this package.

Products Affected

This below products will have no change in their assembly supplier.

Table 1: Hi-Rel (XQ) FPGA Products Affected

Xilinx Product	Change Description
5962-9957201NTB	No change in assembly supplier
XQ4013XL-3PQ240N	No change in assembly supplier
XQV100-4PQ240N	No change in assembly supplier
XQV300-4PQ240N	No change in assembly supplier
XQV600-4PQ240N	No change in assembly supplier

Response

No response is required. For additional information or questions, please contact [Xilinx Technical Support](#).

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<http://www.xilinx.com/support>). Register today and personalize your “Documentation and Design Advisory Alerts” area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to [Xilinx Answer Record 18683](#).

Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
11/24/2014	1.0	Initial release.
03/02/2015	2.0	PCN retracted due to extension of production capability.

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